PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Koji USUDA	10/28/2011
Tsutomu TEZUKA	10/28/2011

RECEIVING PARTY DATA

Name:	KABUSHIKI KAISHA TOSHIBA	
Street Address:	1-1, Shibaura 1-Chome, Minato-Ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13236182

CORRESPONDENCE DATA

Fax Number: (202)408-4400 Phone: 2024084000

Email: bernie.carson@finnegan.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: FINNEGAN

Address Line 1: 901 NEW YORK AVENUE NW

Address Line 4: WASHINGTON, DC, DISTRICT OF COLUMBIA 20001

ATTORNEY DOCKET NUMBER: 02887.0781

NAME OF SUBMITTER: B.Carson

Total Attachments: 2

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OF \$40.00 1323

PATENT REEL: 027330 FRAME: 0160

13G060554USA-A

譲渡証(Translation/日本語訳)

下記に署名した私/私達、は、

ある発明を創出し、これについて合衆国特許出願は

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	に出願され,	出願番号が	交付され,	
	PCT 国際出願	としてに出	願され,	

その発明は

という名称である。 そして、ここにその受領を認める対価で: 私/私達は、当該発明/出願について、合衆国とその属領及び全ての外国に於ける全面的かつ独占的な権利;合衆国とその属領及び全ての外国に於いて発行される特許証に関わる全ての権利、所有権、利益;一部継続出願、継続出願、分割出願、差替え出願、再発行出願、特許期間延長等、合衆国とその属領及び全ての外国に於いて既に出願されたか若しくは今後出願される特許に関わる全ての権利;そして、国際条約、同盟、契約、法令、協定(将来制定されるものを含む)に基づく全ての優先権を伴う一切の権利;を、日本国東京都港区芝浦一丁目1番1号に住所を有する株式会社東芝、その後継者、譲受人及び法定代理人に対して、売却、譲渡、移転するものとする。

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Assignment

For good and valuable consideration, the receipt of which is hereby acknowledged, I/WE, the undersigned,

Koji USUDA and Tsutomu TEZUKA,

who have created a certain Invention for which an application for United States Letters Patent

ited Si	tates Letters Patent	
	executed by ME/US on even date herewith,	
	executed by ME/US on	
	(respectively),	
\boxtimes	filed on September 19, 2011	_
	and assigned Serial No.	
	13/236,182	,
	filed as International Application No.	
	filed on ,	

and entitled:

SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

Do hereby sell, assign and transfer to KABUSHIKI KAISHA TOSHIBA, a corporation of Japan, having a place of business at 1-1, Shibaura 1-Chome, Minato-Ku, Tokyo, Japan, its successors. assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties:

Agree that KABUSHIKI KAISHA TOSHIBA, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in sald Assignee, its successors, assigns, or legal representatives; and

そして、私/私達は、この書面により譲渡された権利や財産に 影響する、如何なる譲渡、授権、抵当権、ライセンス等その他 の協定も他の第三者との間で行っていないこと; 下記に署名 した私/私達によって、この書面に記載されている権利が所有 されていることを、当該譲受人、後継者、被譲渡者、及び法定 代理人に対して誓約するものである。

さらに、下記に署名した私/私達はこの譲渡書は英語の部分の 表現によってのみ解釈されることに同意する。

上記を証明するため、私/私達は下記日付で署名する。

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

I/WE, the undersigned do further agree that this Assignment is to be construed solely according to the terms of the English language portions thereof.

IN TESTIMONY WHEREOF I/WE have hereunto set MY/OUR signature seal on the date indicated below.

唯一または第一発明者名		Fuli name of sole or first inventor Koji USUDA	
発明者の署名	日付	Inventor's signature Koyi' Usuda	Date Uctober 28, 2a11
		Full name of second joint inventor Tsutomu TEZUKA	, If any
第二共同発明者の署名	日付	Second Inventor's signature Julianu Teynbr	Date October 28, 2011